AMENDMENTS TO THE SPECIFICATION:

Please amend the paragraph beginning on page 9, line 18, as follows:

In this case, it is desirable that the connection component is a ~~vis~~ via, and is used to fix the circuit board contained within the shield pack to a housing, and the housing has an electric conductive portion connected to the electric conductive layer.

Please amend the paragraph beginning on page 18, line 27, as follows:

As shown in Figs. 8A to 8C, the entire of the printed circuit board 1 on which the electronic components have been mounted is inserted into the shield back 4 having the sack shape. Subsequently, as shown in Fig. 8D, a joint portion 6 of a major portion of an opening portion of the shield pack 4 is fit with each other, and vacuum suction is carried out from a remaining opening portion 7 of the of the shield pack 4. As a result, an inner capacity of the shield pack 4 is reduced, and the shield pack 4 is made closely contact to the surface of the printed circuit board 1 and the surface of the mount components. Subsequently, as shown in Fig. 8E, an electric conductive connection component such as a ~~vis~~ via or a pin is mounted in such a manner that this electric conductive connection component passes through a ground connection portion 21 of the printed circuit board 1 and the shield pack 4. This passing state is shown in Fig. 9. As a consequence, the metal layer 8 of the shield pack 4 can be electrically connected to a ground pattern of the printed circuit board 1. In this case, the projection as the ground connection terminal needs not be provided on the board. Therefore, the safe handling characteristic of the printed circuit board 1 can be increased, and an increase in cost can be suppressed.